

Data sheet acquired from Harris Semiconductor SCHS037B - Revised June 2003

CMOS 8-Stage Static **Bidirectional Parallel/Serial** Input/Output Bus Register

High-Voltage Types (20-Volt Rating)

CD4034B is a static eight-stage parallel-or serial-input parallel-output register. It can be used to:

1) bidirectionally transfer parallel information between two buses, 2) convert serial data to parallel form and direct the parallel data to either of two buses, 3) store (recirculate) parallel data, or 4) accept parallel data from either of two buses and convert that data to serial form. Inputs that control the operations include a single-phase CLOCK (CL), A DATA ENABLE (AE), ASYNCHRO-NOUS/SYNCHRONOUS (A/S), A-BUS-TO-B-BUS/B-BUS-TO-A-BUS (A/B), and PAR-ALLEL/SERIAL (P/S).

Data inputs include 16 bidirectional parallel data lines of which the eight A data lines are inputs (3-state outputs) and the B data lines are outputs (inputs) depending on the signal level on the A/B input. In addition, an input for SERIAL DATA is also provided.

All register stages are D-type master-slave flip-flops with separate master and slave clock inputs generated internally to allow synchronous or asynchronous data transfer from master to slave. Isolation from external noise and the effects of loading is provided by output buffering.

PARALLEL OPERATION

A high P/S input signal allows data transfer into the register via the parallel data lines synchronously with the positive transition of the clock provided the A/S input is low. If the A/S input is high the transfer is independent of the clock. The direction of data flow is controlled by the A/B input. When this signal is high the A data lines are inputs (and B data lines are outputs); a low A/B signal reverses the direction of data flow.

The AE input is an additional feature which allows many registers to feed data to a common bus. The A DATA lines are enabled only when this signal is high.

Data storage through recirculation of data in each register stage is accomplished by making the A/B signal high and the AE signal low.

Applications:

- Parallel Input/Parallel Output. Serial Input/Parallel Output,
- Shift right/shift left register

- **Buffer register**
- lines at bus side
- Double bus register system
- Pseudo-random code generators
- counting, display)
- Frequency and phase comparator

SERIAL OPERATION

A low P/S signal allows serial data to transfer into the register synchronously with the positive transition of the clock. The A/S input is internally disabled when the register is in the serial mode (asynchronous serial operation is not allowed).

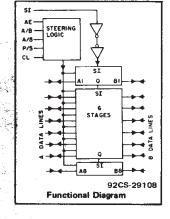
The serial data appears as output data on either the B lines (when A/B is high) or the A lines (when A/B is low and the AE signal is high).

Register expansion can be accomplished by simply cascading CD4034B packages.

The CD4034B types are supplied in 24-lead suffix), 24-lead dual-in-line plastic packages (E suffix), 24-lead small-outline packages (M, M96, and NSR suffixes), and 24-lead thin shrink small-outline packages (PW and PWR suffixes).

hermetic dual-in-line ceramic packages (F3A

- Serial Input/Serial Output Register
- Shift right/shift left with parallel loading
- Address register
- Bus system register with enable parallel
- **Up-Down Johnson or ring counter**
- Sample and hold register (storage,



CD4034B Types

Features:

- Bidirectional parallel data input
- Parallel or serial inputs/parallel outputs
- Asynchronous or synchronous parallel data loading
- Parallel data-input enable on "A" data lines (3-state output)
- Data recirculation for register expansion
- Multipackage register expansion
- Fully static operation dc-to-10 MHz (typ.) at V_{DD} = 10 V
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of 1 µA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package-temperature range):

1 V at V_{DD} = 5 V

2 V at V_{DD} = 10 V

2.5 V at V_{DD} = 15 V

■ Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

MAXIMUM RATINGS, Absolute-Maximum Values: DC SUPPLY-VOLTAGE RANGE, (VDD)

Voltages referenced to VSS Terminal)	0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	0.5V to V _{DD} +0.5V
DC INPUT CURRENT, ANY ONE INPUT	±10mA
POWER DISSIPATION PER PACKAGE (PD):	
For T _A = -55°C to +100°C	500mW
For T _A = +100°C to +125°C	. Derate Linearity at 12mW/OC to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package	e Types) 100mW
OPERATING-TEMPERATURE RANGE (TA)	55°C to +125°C
STORAGE TEMPERATURE RANGE (Tstg)	
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 \pm 1/32 inch (1.59 \pm 0.79mm) from case for 10s in	max +265°C

RECOMMENDED OPERATING CONDITIONS at $T_A = 25^{\circ}$ C, Except as Noted. For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	V _{DD}	LIM	LINUTO	
CHARACTERISTIC	(V)	Min.	Max.	UNITS
Supply-Voltage Range (For T_A = Full Package- Temperature Range)		3	18	V
Data Setup Time, t _S	5	160	_	
Serial Data to Clock	10	60	- 1	ns
	15	40		
	5	50		
Parallel Data to Clock	10	30	-	ns
· ·	15	20	_	
	5	350	-	
Clock Pulse Width, t _W	10	140	_	ns
	15	80	_	
	5		2	
Clock Input Frequency, f _{CL}	10	dc	5	MHz
	15		7	
Clock Input Rise or Fall Time, t _r CL, t _f CL*	5, 10, 15	_	15	μs

^{*}If more than one unit is cascaded t_rCL should be made less than or equal to the sum of the transition time and the fixed propagation delay of the output of the driving stage for the estimated capacitive load.

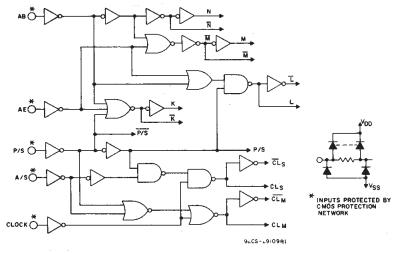


Fig. 1 - Steering logic diagram.

FLIP-FLOP TRUTH TABLE

	OUTPUT		
CL _M	<u>CL</u> S	D	Q
		0	0
		0	0
__	_	0	INVALID CONDITION
		Х	0
	_	1	1
		1	1
		1	INVALID

1 = High Level 0 = Low Level X = Don't Care

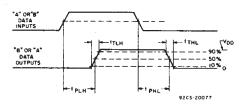
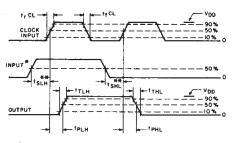


Fig. 2 — Asynchronous operation propagation delay time and transition time.



- * INPUT REFERS TO ANY OF THE "A"OR "B" DATA INPUTS, "A"ENABLE, SERIAL INPUT, A/B, P/S, OR A/S INPUTS
- ** TSLH AND TSHL ARE SET-UP TIMES

Fig. 3 — Synchronous operation propagation delay times, transition times, and set-up times.

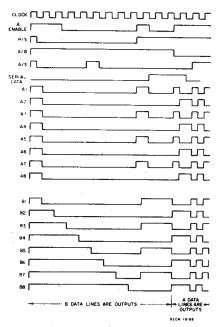


Fig. 4 - Timing diagram.

CHARAC- TERISTIC	CONDITIONS			DITIONS LIMITS AT INDICATED TEMPERATURES (°C)											C)	U N I T
	v _O	VIN	v _{DD}		40		4.55		+25		S					
	(V)	(V)	(V)	-55	40	+85	+125	Min.	Тур.	Max.						
Quiescent		0,5	5	5	5	150	150		0.04	5						
Device		0,10	10	10	10	300	300	_	0.04	10	μΑ					
Current,		0,15	15	20	20	600	600		0.04	20						
55	-	0,20	20	100	100	3000	3000		0.08	100						
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	_						
(Sink) Current	0.5	0,10	10	1.6	- 1.5	1.1	0.9	1.3	2.6	-						
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	_						
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	1	_	mΑ					
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2							
Current,	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6							
I _{OH} Min.	13.5	0,15	15	-4.2	4	-2.8	-2.4	-3.4	-6.8	-						
Output Voltage:		0,5	5	0.05 - 0 0.05												
Low-Level,	_	0,10	10		0.	.05		0	0.05							
VOL Max.		0,15	15	0.05					0	0.05	v					
Output		0,5	- 5	4.95 4.95 5 –												
Voltage: High-Level,	_	0,10	10		9	9.95	10	_								
VOH Min.	-	0,15	15		14.95 14.95 15											
Input Low	0.5,4.5		5			1.5		_	_	1.5						
Voltage	1,9	_	10			3		_	_	3						
V _{IL} Max.	1.5,13.5		15	4						4	l v					
Input High	0.5,4.5	_	5	3.5 3.5												
Voltage,	1,9	_	10	7 7 –						-						
V _{IH} Min.	1.5,13.5	_	15	11 11						-	1					
Input Current* I _{IN} Max.	-	0,18	18	±0.1	±0.1	±1	±1	-	±10 ⁻⁵	±0.1	μΑ					
3-State Output Leakage Current IOUT Max.	0,18	0,18	18	±0.4	±0.4	±12	±12)	±10 ⁴	±0.4	μΑ					

Fig. 5 — Typical output low (sink) current characteristics.

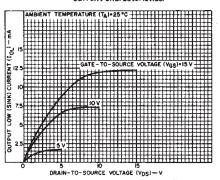


Fig. 6 - Minimum output low (sink) current characteristics.

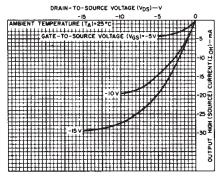


Fig. 7 — Typical output high (source) current characteristics.

^{*} All inputs except A and B Lines.

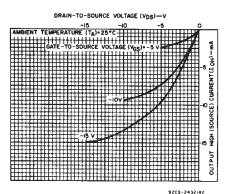


Fig. 8 — Minimum output high (source) current characteristics.

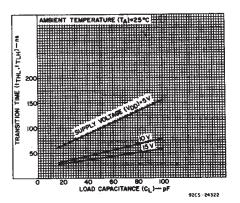


Fig. 9 — Typical transition time as a function of load capacitance.

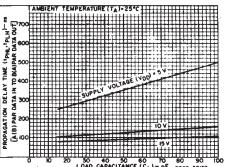


Fig. 10 — Typical propagation delay time as a function of load capacitance (A(B) parallel Data Input to B(A) parallel Data Output, synchronous or asynchronous].

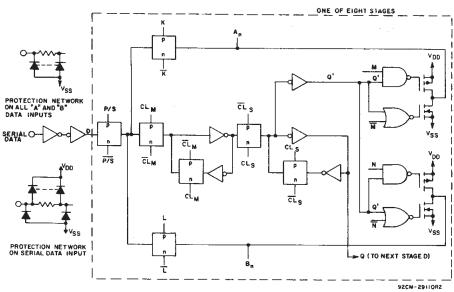


Fig. 11 - Register stage logic diagram (1 of 8 stages).

TRUTH TABLE FOR REGISTER INPUT-LEVELS AND RESULTING REGISTER OPERATION

"A" Enable	P/S	A/B	A/S	Operation*
0	0	0	х	Serial Mode; Synch. Serial Data Input, "A" Parallel Data Outputs Disabled
0	0	1	Х	Serial Mode; Synch. Serial Data Input, "B" Parallel Data Output
0	1	0	0	Parallel Mode; "B" Synch. Parallel Data Inputs, "A" Parallel Data Outputs Disabled
0	1	0	1	Parallel Mode; "B" Asynch. Parallel Data Inputs, "A" Parallel Data Outputs Disabled
0	1	1	0	Parallel Mode; "A" Parallel Data Inputs Disabled, "B" Parallel Data Outputs, Synch. Data Recirculation
0	1	1	1	Parallel Mode; "A" Parallel Data Inputs Disabled, "B" Parallel Data Outputs, Asynch. Data Recirculation
1	0	0	Х	Serial Mode; Synch. Serial Data Input, "A" Parallel Data Output
1	0	1	Х	Serial Mode; Synch. Serial Data Input, "B" Parallel Data Output
1	1	0	0	Parallel Mode; "B" Synch. Parallel Data Input, "A" Parallel Data Output
1	1	0	1	Parallel Mode; "B" Asynch. Parallel Data Input, "A" Parallel Data Output
1	1	1	0	Parallel Mode; "A" Synch. Parallel Data Input, "B" Parallel Data Output
1	1	1	1	Parallel Mode; "A" Asynch. Parallel Data Input, "B" Parallel Data Output

^{*}Outputs change at positive transition of clock in the serial mode and when the A/S control input is "low" in the parallel mode. During transfer from parallel to serial operation A/S should remain low in order to prevent D_S transfer into Flip Flops.

1 = HIGH LEVEL

0 = LOW LEVEL

X = DON'T CARE

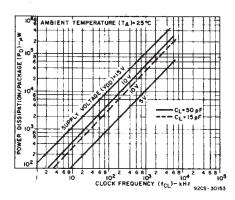


Fig. 12 — Typical dynamic power dissipation as a function of clock frequency.

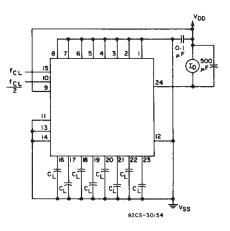


Fig. 13 — Dynamic power dissipation test circuit.

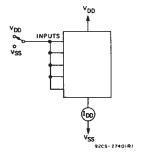


Fig. 14 - Quiescent-device-current test circuit.

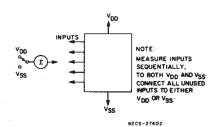


Fig. 15 - Input-current test circuit.

DYNAMIC ELECTRICAL CHARACTERISTICS at TA = 25°C; Input t, tt = 20 ns,

 $C_L = 50 pF$, $R_L = 200 k\Omega$

CHARACTERIST	10	V _{DO} (V)		UNITS		
CHANAC I ENIST	OHARAO I ERIGITO		MIN.	TYP.	MAX.	UNITS
Propagation Delay Time,	tehl, telh	5	_	350	700	
A(B) Parallel Data In to		10	_	120	240	i
B(A) Parailel Data Out		15	_	85	170	
Serial to Parallel Data O	ut	1				
3-State Propagation Delay	tpLZ,tpHZ	- 5	_	200	400	1
A/B or AE to "A" OUT	t _{PZL} , t _{PZH}	10	_	80	160	
	4	15	l –	60	120	
Transition Time,	tthe, tteh	- 5		100	200	1
		10	-	50	100	İ
		15	l –	40	80	
Minimum Data Setup Time	, t _{su}	5		80	160	1
Serial Data to Clock	•	10	_	30	60	ns
		15	_	20	40	
		5	-	25	50	1
Parallel Data to Clo	ck	10		15	30	
		15	_	10	. 20	
Minimum Data Hold Time,	t _H	5	_	_	50	1
		10	<u> </u>	-	15	
		15	<u> </u>	-	10	
Minimum High-Level		5		175	350	1
Pulse Width,	tw	10	-	70	140	
AE, P/S, A/S		15	-	40	80	i
Maximum Clock		5	2	4		
Frequency,	f _{CL}	10	5	10	_	MHz
		15	7	14		
Minimum Clock Pulse		5		125	250	
Width,	tw .	10	_	50	100	ns
		15	_	35	70	
Maximum Clock Rise or		5 10 15			15	<u> </u>
Fall Time,	trCL, trCL*	5,10,15	_	-	'5	μS
Input Capacitance,	Cin	Any Input		5	7.5	pF

92CS-2744IRI
Fig. 16 — Input-voltage test circuit.

Applications

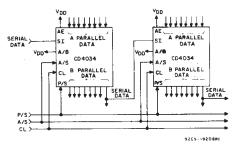
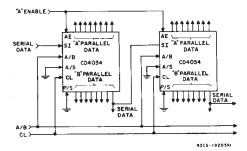
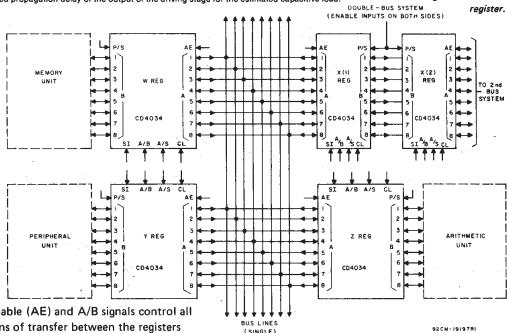


Fig. 17 — 16-bit parallel in/parallel out, parallel in/serial out, serial in/ parallel out, serial in/serial out register.



*If more than one unit is cascaded tCL should be made less than or equal to the sum of the transition time and the fixed propagation delay of the output of the driving stage for the estimated capacitive load.

Fig. 18 — 16-bit serial in/gated parallel out



The "A" enable (AE) and A/B signals control all combinations of transfer between the registers and bus systems.

Fig. 15

Fig. 19 - Single- and double-bus systems.

VIH OUTPUTS

VIL OUTPUTS

OUTPUTS

OUTPUTS

OUTPUTS

NOTE:
TEST ANY COMBINATION OF INPUTS

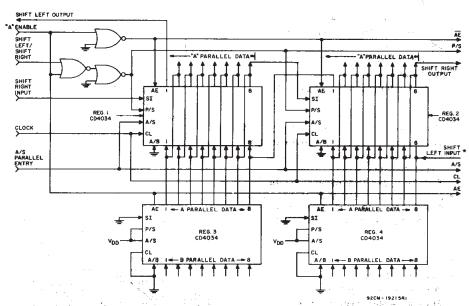


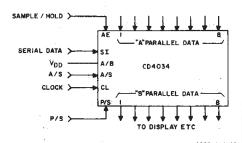
Fig. 20- Shift right/shift left with parallel inputs.

A "High" ("Low") on the shift Left/Shift Right input allows serial data on the Shift Left Input (Shift Right Input) to enter the register on the positive transition of the clock signal. A "high" on the "A" Enable Input disables the "A" parallel data lines on Reg. 1 and 2 and enables the "A" data lines on registers 3 and 4 and allows parallel data

into registers 1 and 2. Other logic schemes may be used in place of registers 3 and 4 for parallel loading.

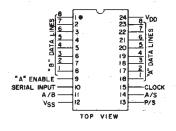
When parallel inputs are not used Reg. 3 and 4 and associated logic are not required.

Fig. 21 - N-stage shift register with fixed serial output line.



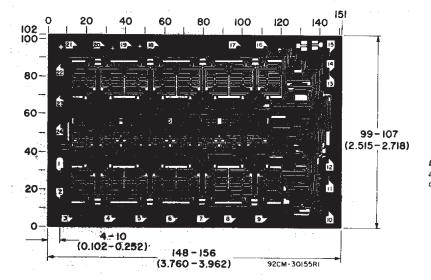
parallel in-parallel out.

Fig. 22 - Sample and hold register-serial/



TERMINAL DIAGRAM

9205-20744RI



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10-3 inch).

Dimensions and pad layout for CD4034BH.

Shift left input must be disabled during parallel





ti.com 28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp (3)
CD4034BE	ACTIVE	PDIP	N	24	15	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4034BF3A	ACTIVE	CDIP	J	24	1	None	Call TI	Level-NC-NC-NC
CD4034BM	ACTIVE	SOIC	DW	24	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
CD4034BM96	ACTIVE	SOIC	DW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
CD4034BNSR	ACTIVE	SO	NS	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4034BPW	ACTIVE	TSSOP	PW	24	60	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4034BPWR	ACTIVE	TSSOP	PW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

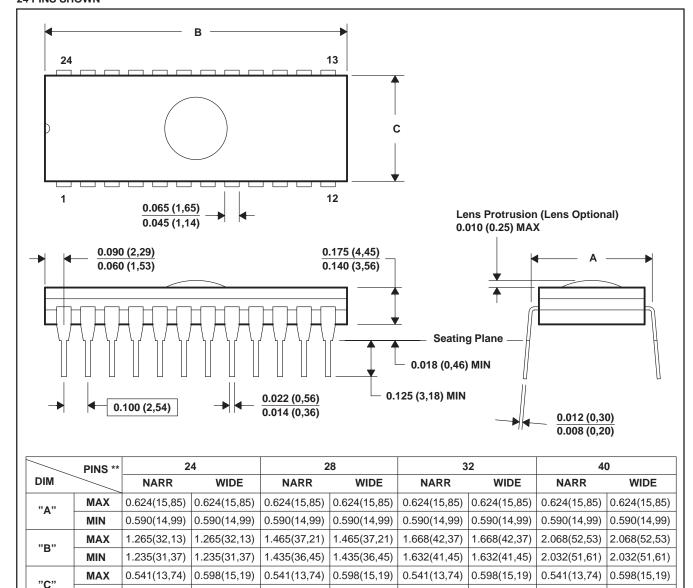
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J (R-GDIP-T**)

24 PINS SHOWN

CERAMIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

0.514(13,06)

MIN

- B. This drawing is subject to change without notice.
- C. Window (lens) added to this group of packages (24-, 28-, 32-, 40-pin).

0.571(14,50)

D. This package can be hermetically sealed with a ceramic lid using glass frit.

0.514(13,06)

E. Index point is provided on cap for terminal identification.



0.571(14,50)

0.514(13,06)

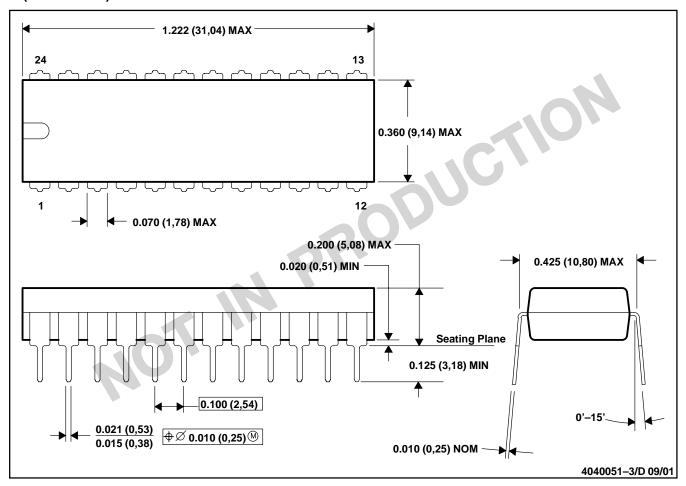
0.571(14,50)

0.514(13,06) | 0.571(14,50)

4040084/C 10/97

N (R-PDIP-T24)

PLASTIC DUAL-IN-LINE



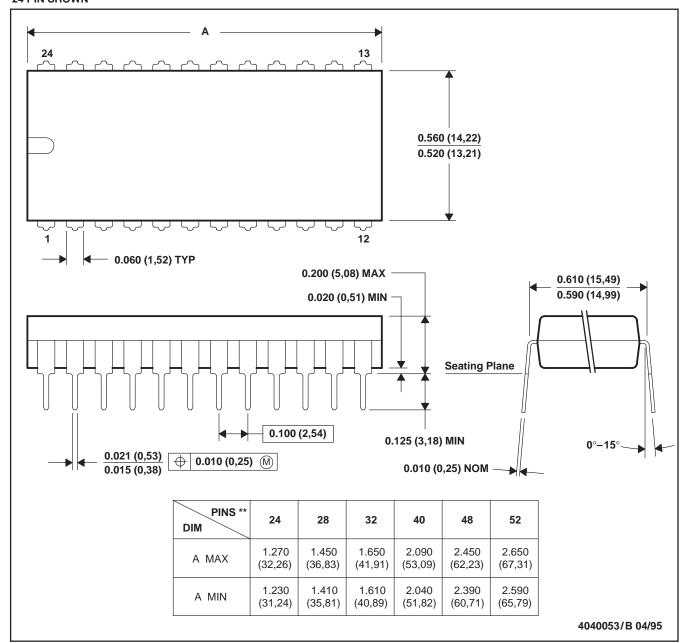
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-010

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PIN SHOWN



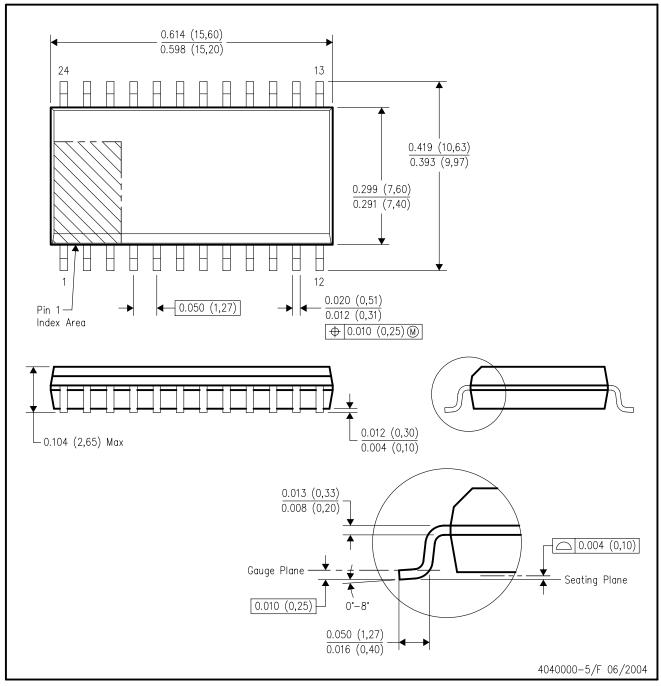
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-011
- D. Falls within JEDEC MS-015 (32 pin only)



DW (R-PDSO-G24)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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